



- NOTES:
1. ALL EXPOSED METALLIZED AREA SHALL BE GOLD PLATED 60 MICRO INCH MIN. THK. OVER NICKEL PLATED UNLESS OTHERWISE SPECIFIED PURCHASE ORDER.
 2. FLATNESS METALLIZED PAD'S ONLY.
 3. SEAL AREA AND DIE ATTACH AREA SHALL BE ISOLATED FROM ANY LEAD'S. (ZERO GROUND)

REV.	REVISION	MATERIAL	TOLERANCE	SCALE	DIMENSION	PROJECTION	TITLE
		90%MIN AL 2C3 (NA-301B BLACK)	±1% N.L.T. ±.005	8:1	INCH(mm)	3rd	28L C/C
		APPROVED	CHECKED	ENGRG	CHECKED	DESIGNED	PART NO.
							229601
							DWG NO.
							M3- 02186 -R 01
							SHT/DF
							1/1

Sumitomo Metal (SMI) Electronics Devices Inc.

